

## 1.6X1.25mm BI-COLOR SMD CHIP LED LAMP

Part Number: KPTB-1612SURKCGKC

Hyper Red Green

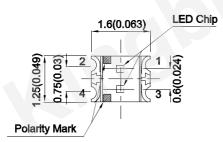
#### **Features**

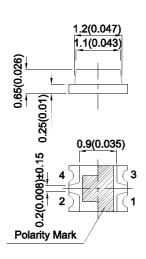
- 1.6mmx1.25mm SMD LED, 0.65mm thickness.
- Bi-color,low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- · RoHS compliant.

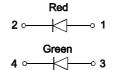
## **Descriptions**

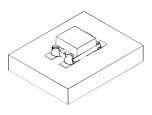
- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.
- The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

## **Package Dimensions**









#### Notes:

- All dimensions are in millimeters (inches).
   Tolerance is ±0.2(0.008") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

4. The device has a single mounting surface. The device must be mounted according to the specifications.

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## **Selection Guide**

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
KPTB-1612SURKCGKC	Hyper Red (AlGaInP)	Water Clear	120	200	- 150°
			*40	*80	
	Green (AlGalnP)		20	50	
			*20	*50	

#### Notes:

- $1. \theta 1/2$  is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Luminous intensity / luminous Flux: +/-15%
- \* Luminous intensity value is traceable to CIE127-2007 standards.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green	645 574		nm	I==20mA
λD [1]	Dominant Wavelength	Hyper Red Green	630 570		nm	I==20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green	28 20		nm	I==20mA
С	Capacitance	Hyper Red Green	35 15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red Green	1.95 2.1	2.5 2.5	V	I==20mA
lR	Reverse Current	Hyper Red Green		10 10	uA	VR = 5V

## Notes:

- Wavelength: +/-1nm.
   Forward Voltage: +/-0.1V.
   Wavelength value is traceable to CIE127-2007 standards.
- 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

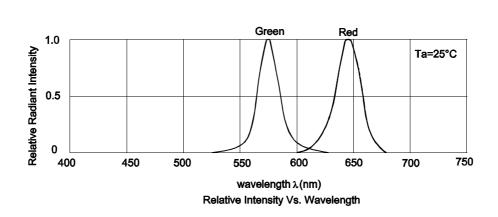
## Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Green	Units		
Power dissipation	75	75	mW		
DC Forward Current	30	30	mA		
Peak Forward Current [1]	185	150	mA		
Reverse Voltage	5				
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

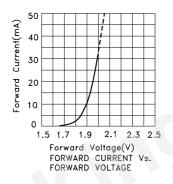
#### Notes:

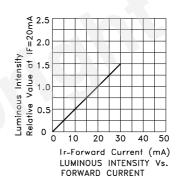
- 1.1/10 Duty Cycle, 0.1ms Pulse Width.
   Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

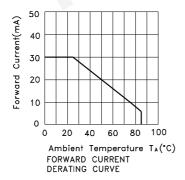
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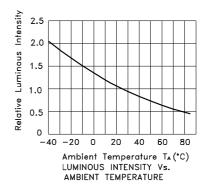


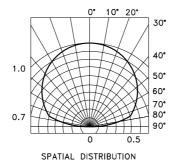
## KPTB-1612SURKCGKC Hyper Red





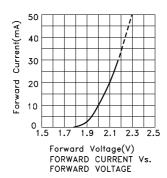


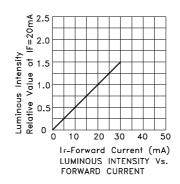


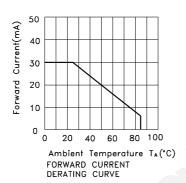


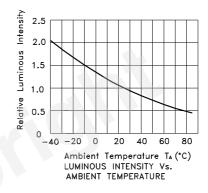
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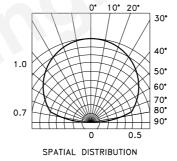
## Green









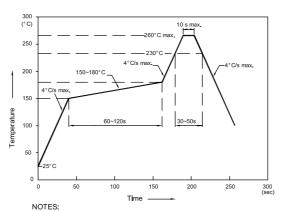


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## **KPTB-1612SURKCGKC**

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



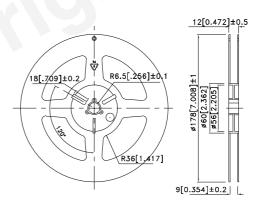
- 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
- 2. Don't cause stress to the epoxy resin while it is exposed
- to high temperature.
  3.Number of reflow process shall be 2 times or less.

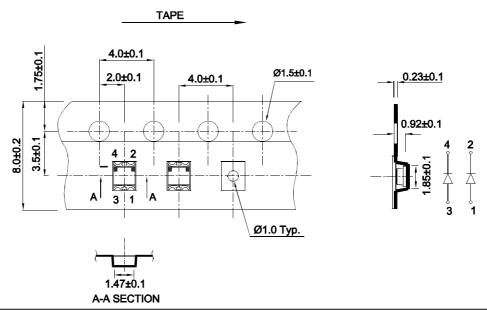
## Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

# 0.8

## Tape Dimensions (Units: mm)

## **Reel Dimension**

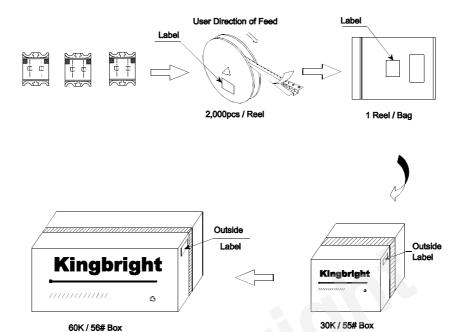


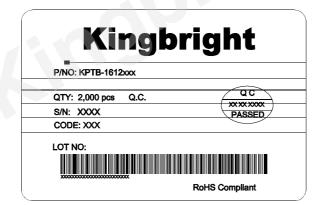


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## **PACKING & LABEL SPECIFICATIONS**

#### **KPTB-1612SURKCGKC**





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